

# **FACT SHEET**

## **IPC-6012C**

52 pages 24 illustrations 12 are new or updated

Scope: Qualification and performance requirements for producing bare printed boards with level of inspection and test.

# IPC-A-600H

147 pages 326 pictures and illustrations 95 are new or updated

Scope: Printed board fabrication acceptance criteria provided as text and supported by full color pictures and drawings. (This document is a visual support document to the IPC-6012C performance specification.)

### **Changes common to both documents**

- Measles criteria is now aligned between IPC-6012C, IPC-A-600H, J-STD-001E and IPC-A-610E.
- Cap plating of filled vias, including required plating thickness and allowances for protrusions (bumps) and depressions (dimples).
- Updated requirements for material fill of blind and buried vias.
- Copper wrap plating in plated holes, including allowances for reduction of "wrap" copper at the knee of plated holes as a result of planarization processes.
- Updated surface laminate criteria, including weave exposure, disrupted fibers and haloing.
- Updated cross-section requirements, including laminate voids/cracks, etchback and barrel separation.
- Significant changes from previous versions are identified by shaded text.

#### IPC-6012C changes

- New criteria for surface finishes such as ENIG, ENEPIG, immersion silver, immersion tin and OSP.
- New criteria for thermal stress testing, including assembly reflow simulation methods.
- Updated acceptance testing and frequency requirements based on end product class.
- Updated requirements for selection for procurement.

### **IPC-A-600H** changes

- New flex circuitry criteria for stiffener bonding, solder wicking, laminate voids/cracks and fold/bend marks.
- New or updated pictures and illustrations for more than 40 separate sections.

#### **Training and Certification**

Two tier "Train the Trainer" Concept; Industry Developed, Approved and Traceable

- Certified IPC Trainer (complete document)
- Certified IPC Application Specialist (modular so training can be tailored to job functions and requirements)
- Training is primarily to visual appearance as shown in IPC-A-600H but the requirements and test methods of IPC-6012C and IPC-6013B are included.

#### **Support documents**

- IPC-J-STD-003B, Solderability Tests for Printed Boards
- IPC-SM-840D, Qualification and Performance Specification of Permanent Solder Mask
- IPC-4550 Series of Plating Specifications, including IPC-4552 for ENIG, IPC-4553 for Immersion Silver, and IPC-4554 for Immersion Tin
- IPC-4562A , Metal Foil for Printed Wiring Applications
- IPC-6011, Generic Performance Specification for Printed Boards
- IPC-9252A, Requirements for Electrical Testing of Unpopulated Printed Boards